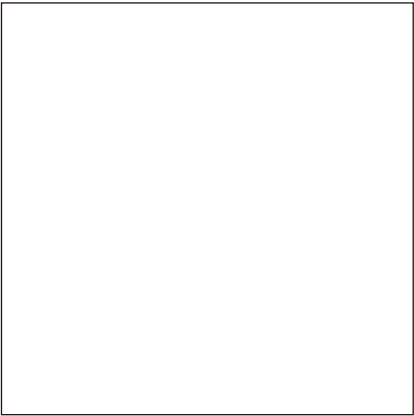
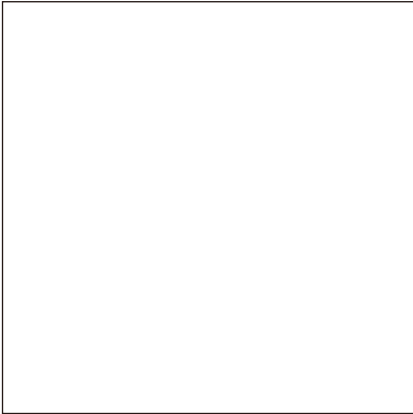
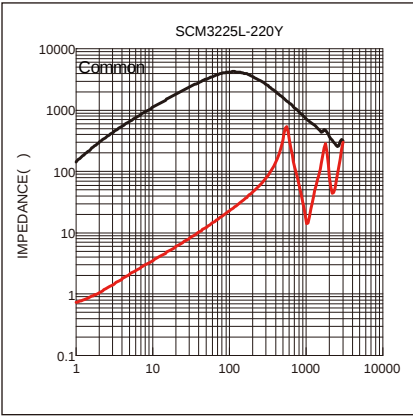
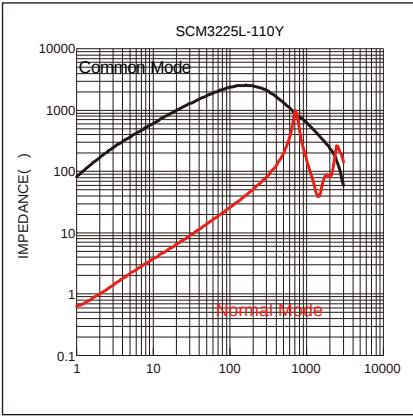
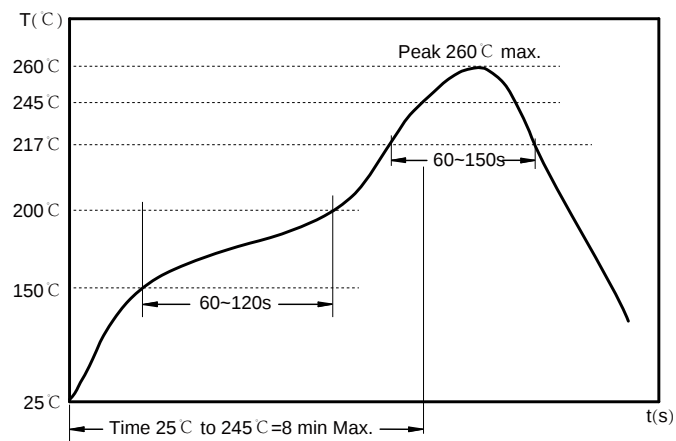


Typical Electrical Characteristics:



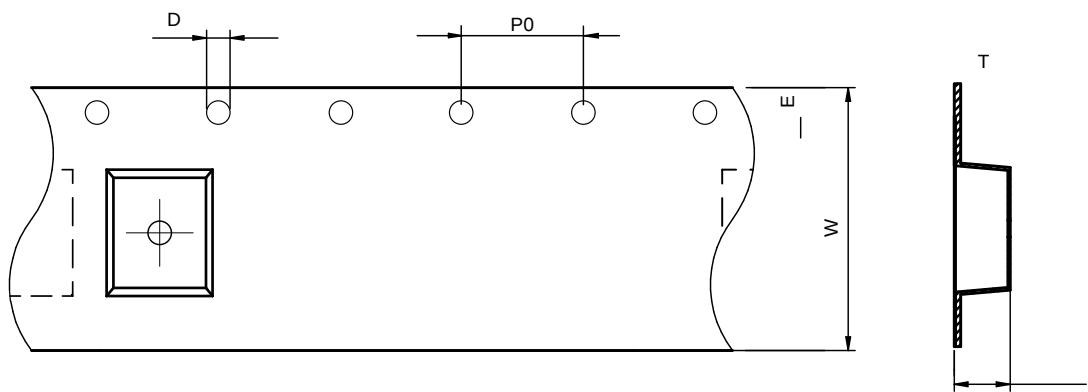
Soldering Reflow:



Preheat condition: 150 ~200 °C / 60~120 sec.
Allowed time above 217 °C: 60~150 sec.
Max temperature: 260 °C .

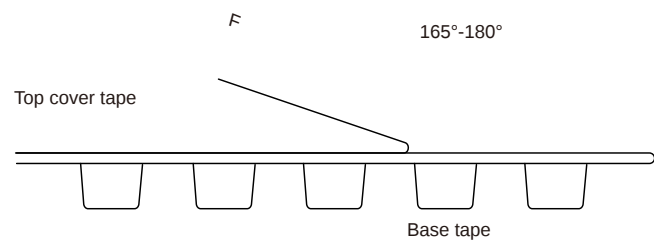
Packaging Information:

Tape Dimension :



Series	A0 (mm)	B0 (mm)	D (mm)	P0 (mm)	P1 (mm)	W (mm)	K0 (mm)	E (mm)	T (mm)
SCM3225L	2.88 ± 0.1	3.72 ± 0.1	1.5 ± 0.1	4.0 ± 0.1	4.0 ± 0.1	8.0 ± 0.3	2.5 ± 0.1	1.75 ± 0.1	0.26 ± 0.05

Peel force of top cover tape:



Reel Dimension: [mm]

